

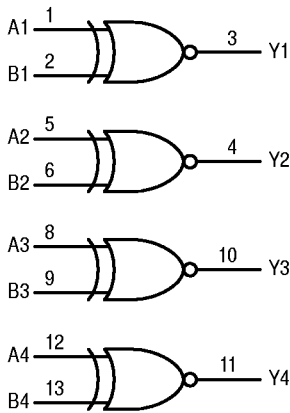
# Quad 2-Input Exclusive NOR Gate

## High-Performance Silicon-Gate CMOS

The MC74HC7266A is identical in pinout to the LS266 and the HC266. The HC7266 has standard CMOS outputs instead of open-drain outputs. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: 1  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 56 FETs or 14 Equivalent Gates

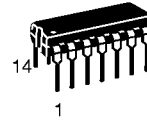
### LOGIC DIAGRAM



$$Y = A \oplus B = AB + \overline{A}B$$

PIN 14 = VCC  
PIN 7 = GND

# MC74HC7266A



**N SUFFIX**  
PLASTIC PACKAGE  
CASE 646-06



**D SUFFIX**  
SOIC PACKAGE  
CASE 751A-03

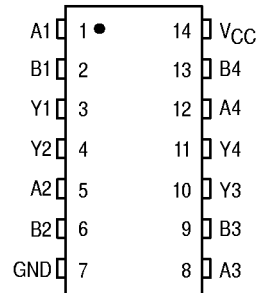


**DT SUFFIX**  
TSSOP PACKAGE  
CASE 948G-01

### ORDERING INFORMATION

|              |         |
|--------------|---------|
| MC74HCXXXAN  | Plastic |
| MC74HCXXXAD  | SOIC    |
| MC74HCXXXADT | TSSOP   |

### PIN ASSIGNMENT



### FUNCTION TABLE

| Inputs |   | Output |
|--------|---|--------|
| A      | B | Y      |
| L      | L | H      |
| L      | H | L      |
| H      | L | L      |
| H      | H | H      |



# MC74HC7266A

## MAXIMUM RATINGS\*

| Symbol    | Parameter   | Value   | Unit              |    |
|-----------|---|---|-------------------|----|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)   | - 0.5 to + 7.0                                  | V                 |    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)  | - 0.5 to $V_{CC} + 0.5$                         | V                 |    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)   | - 0.5 to $V_{CC} + 0.5$                         | V                 |    |
| $I_{in}$  | DC Input Current, per Pin   | $\pm 20$  | mA                |    |
| $I_{out}$ | DC Output Current, per Pin  | $\pm 25$  | mA                |    |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins  | $\pm 50$  | mA                |    |
| $P_D$     | Power Dissipation in Still Air  | Plastic DIP†<br>SOIC Package†<br>TSSOP Package† | 750<br>500<br>450 | mW |
| $T_{stg}$ | Storage Temperature   | - 65 to + 150                                   | °C                |    |
| $T_L$     | Lead Temperature, 1 mm from Case for 10 Seconds<br>(Plastic DIP, SOIC or TSSOP Package) | 260   | °C                |    |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

\* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

† Derating — Plastic DIP: - 10 mW/°C from 65° to 125°C  
SOIC Package: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

## RECOMMENDED OPERATING CONDITIONS

| Symbol            | Parameter  | Min  | Max         | Unit               |    |
|-------------------|--|--|-------------|--------------------|----|
| $V_{CC}$          | DC Supply Voltage (Referenced to GND)                | 2.0  | 6.0         | V                  |    |
| $V_{in}, V_{out}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0  | $V_{CC}$    | V                  |    |
| $T_A$             | Operating Temperature, All Package Types             | - 55   | + 125       | °C                 |    |
| $t_r, t_f$        | Input Rise and Fall Time<br>(Figure 1)               | $V_{CC} = 2.0 \text{ V}$<br>$V_{CC} = 4.5 \text{ V}$<br>$V_{CC} = 6.0 \text{ V}$ | 0<br>0<br>0 | 1000<br>500<br>400 | ns |

## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol   | Parameter                         | Test Conditions  | $V_{CC}$<br>V | Guaranteed Limit |                         |                          | Unit |
|----------|-----------------------------------|--|---------------|------------------|-------------------------|--------------------------|------|
|          |                                   |  |               | - 55 to<br>25°C  | $\leq 85^\circ\text{C}$ | $\leq 125^\circ\text{C}$ |      |
| $V_{IH}$ | Minimum High-Level Input Voltage  | $V_{out} = 0.1 \text{ V}$ or $V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$   | 2.0           | 1.5              | 1.5                     | 1.5                      | V    |
|          |                                   |  | 3.0           | 2.1              | 2.1                     | 2.1                      |      |
|          |                                   |  | 4.5           | 3.15             | 3.15                    | 3.15                     |      |
|          |                                   |  | 6.0           | 4.2              | 4.2                     | 4.2                      |      |
| $V_{IL}$ | Maximum Low-Level Input Voltage   | $V_{out} = 0.1 \text{ V}$ or $V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$   | 2.0           | 0.5              | 0.5                     | 0.5                      | V    |
|          |                                   |  | 3.0           | 0.9              | 0.9                     | 0.9                      |      |
|          |                                   |  | 4.5           | 1.35             | 1.35                    | 1.35                     |      |
|          |                                   |  | 6.0           | 1.8              | 1.8                     | 1.8                      |      |
| $V_{OH}$ | Minimum High-Level Output Voltage | $V_{in} = V_{IH}$ or $V_{IL}$<br>$ I_{out}  \leq 20 \mu\text{A}$   | 2.0           | 1.9              | 1.9                     | 1.9                      | V    |
|          |                                   |  | 4.5           | 4.4              | 4.4                     | 4.4                      |      |
|          |                                   |  | 6.0           | 5.9              | 5.9                     | 5.9                      |      |
|          |                                   | $V_{in} = V_{IH}$ or $V_{IL}$<br>$ I_{out}  \leq 2.4 \text{ mA}$<br>$ I_{out}  \leq 4.0 \text{ mA}$<br>$ I_{out}  \leq 5.2 \text{ mA}$ | 3.0           | 2.48             | 2.34                    | 2.20                     |      |
|          |                                   |  | 4.5           | 3.98             | 3.84                    | 3.70                     |      |
|          |                                   |  | 6.0           | 5.48             | 5.34                    | 5.20                     |      |

**DC ELECTRICAL CHARACTERISTICS** (Voltages Referenced to GND)

| Symbol          | Parameter                                      | Test Conditions  | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|-----------------|--|--|----------------------|------------------|--------|---------|------|
|                 |  |  |                      | - 55 to 25°C     | ≤ 85°C | ≤ 125°C |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA  | 2.0                  | 0.1              | 0.1    | 0.1     | V    |
|                 |  |  | 4.5                  | 0.1              | 0.1    | 0.1     |      |
|                 |  |  | 6.0                  | 0.1              | 0.1    | 0.1     |      |
|                 |  | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 2.4 mA<br> I <sub>out</sub>   ≤ 4.0 mA<br> I <sub>out</sub>   ≤ 5.2 mA | 3.0                  | 0.26             | 0.33   | 0.40    |      |
|                 |  |  | 4.5                  | 0.26             | 0.33   | 0.40    |      |
|                 |  |  | 6.0                  | 0.26             | 0.33   | 0.40    |      |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> = V <sub>CC</sub> or GND   | 6.0                  | ± 0.1            | ± 1.0  | ± 1.0   | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> = V <sub>CC</sub> or GND<br>I <sub>out</sub> = 0 μA  | 6.0                  | 1                | 10     | 40      | μA   |

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

**AC ELECTRICAL CHARACTERISTICS** (C<sub>L</sub> = 50 pF, Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

| Symbol                                 | Parameter  | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|--|--|----------------------|------------------|--------|---------|------|
|  |  |                      | - 55 to 25°C     | ≤ 85°C | ≤ 125°C |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A or B to Output Y<br>(Figures 1 and 2) | 2.0                  | 100              | 125    | 150     | ns   |
|  |  | 3.0                  | 80               | 90     | 110     |      |
|  |  | 4.5                  | 20               | 25     | 25      |      |
|  |  | 6.0                  | 17               | 21     | 19      |      |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 1 and 2)          | 2.0                  | 75               | 95     | 110     | ns   |
|  |  | 3.0                  | 30               | 40     | 55      |      |
|  |  | 4.5                  | 15               | 19     | 22      |      |
|  |  | 6.0                  | 13               | 16     | 19      |      |
| C <sub>in</sub>                        | Maximum Input Capacitance  | —                    | 10               | 10     | 10      | pF   |

NOTES:

1. For propagation delays with loads other than 50 pF, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).
2. Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

| C <sub>PD</sub> | Power Dissipation Capacitance (Per Gate)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V |  | pF |
|-----------------|---|---|--|----|
|                 |   | 33                                      |  |    |
|                 |   |   |  |    |

\* Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup>f + I<sub>CC</sub> V<sub>CC</sub>. For load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

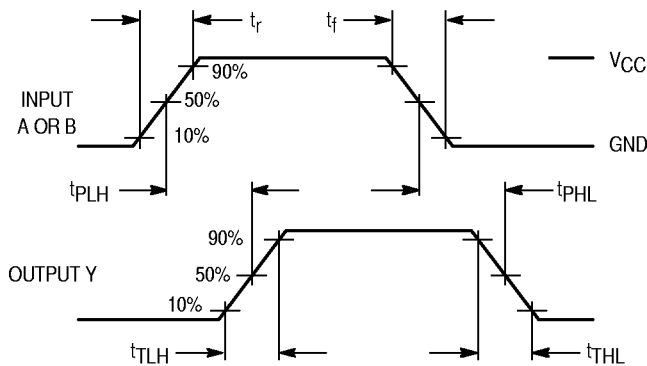
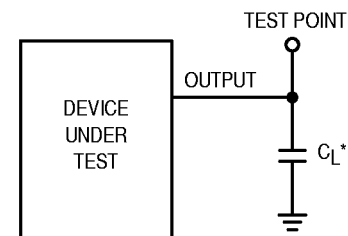


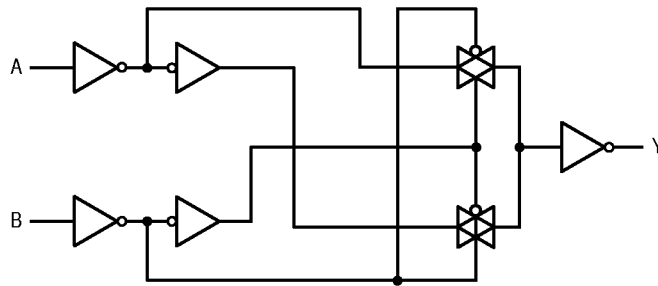
Figure 1. Switching Waveforms



\* Includes all probe and jig capacitance

Figure 2. Test Circuit

**LOGIC DETAIL**  
(1/4 of Device)



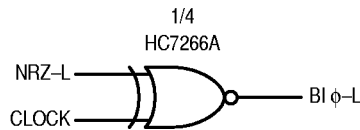
**APPLICATION INFORMATION**

Bi  $\phi$ -L is defined as biphas-level code. Also known as Manchester Code, this technique utilizes binary phase shift keying (PSK). The Bi  $\phi$ -L output shown in Figure 3 carries both data and synchronization information; therefore, separate data and clock lines are not required to transfer information. A positive-going transition in the middle of the bit interval indicates a logic zero; a negative-going transition in-

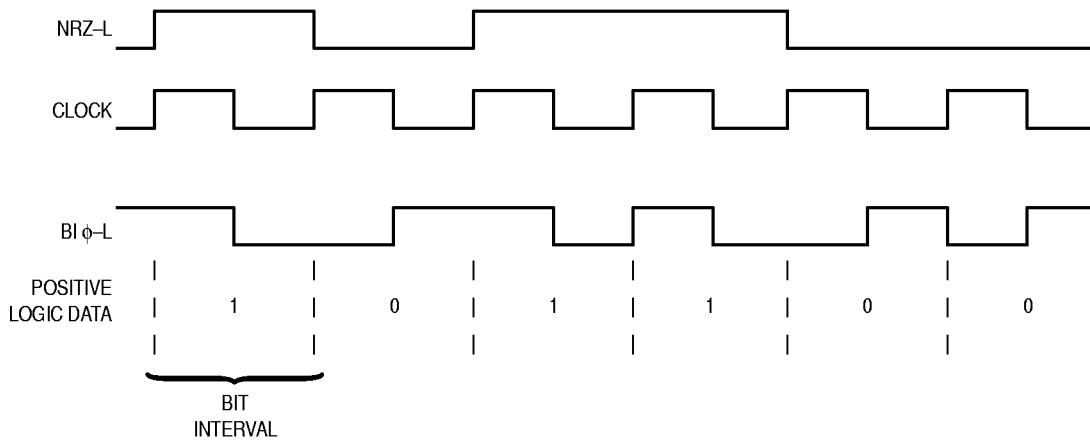
dicates a logic one (see Figure 4).

NRZ-L shown in Figure 3 is non-return-to-zero level code. This is simply serial data out of a shift register, such as the HC597.

The Bi  $\phi$ -L signal must be phase coherent (i.e., no glitches). Therefore, NRZ-L and clock transitions must be coincident.



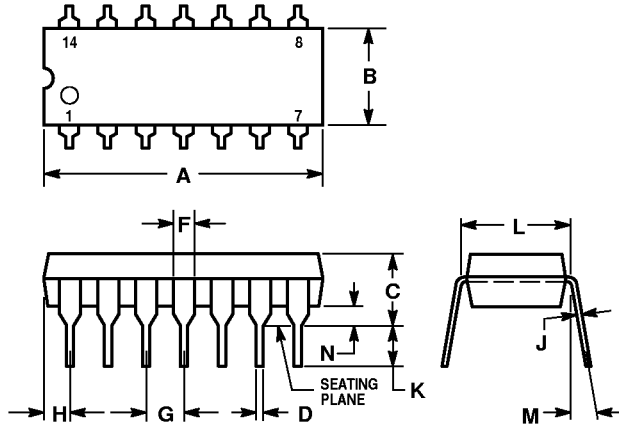
**Figure 3. Biphas-Level Encoder (Manchester Encoder)**



**Figure 4. Timing Diagram**

OUTLINE DIMENSIONS

**N SUFFIX**  
**PLASTIC DIP PACKAGE**  
 CASE 646-06  
 ISSUE L

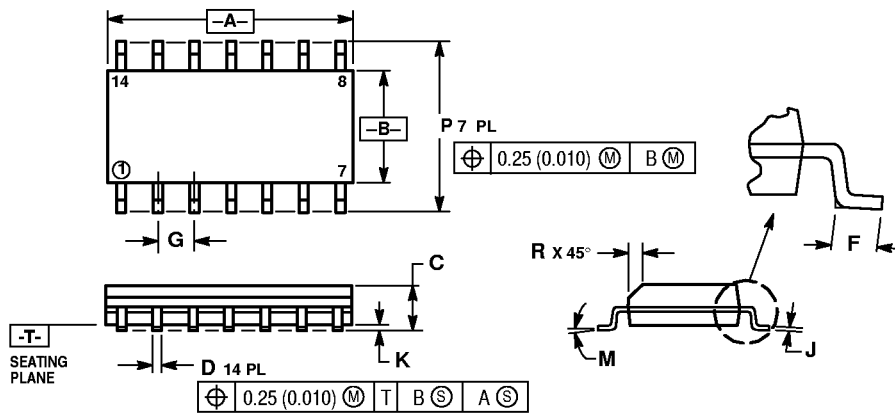


NOTES:

- LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- ROUNDED CORNERS OPTIONAL.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.715     | 0.770 | 18.16       | 19.56 |
| B   | 0.240     | 0.260 | 6.10        | 6.60  |
| C   | 0.145     | 0.185 | 3.69        | 4.69  |
| D   | 0.015     | 0.021 | 0.38        | 0.53  |
| F   | 0.040     | 0.070 | 1.02        | 1.78  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.052     | 0.095 | 1.32        | 2.41  |
| J   | 0.008     | 0.015 | 0.20        | 0.38  |
| K   | 0.115     | 0.135 | 2.92        | 3.43  |
| L   | 0.300 BSC |       | 7.62 BSC    |       |
| M   | 0°        | 10°   | 0°          | 10°   |
| N   | 0.015     | 0.039 | 0.39        | 1.01  |

**D SUFFIX**  
**PLASTIC SOIC PACKAGE**  
 CASE 751A-03  
 ISSUE F



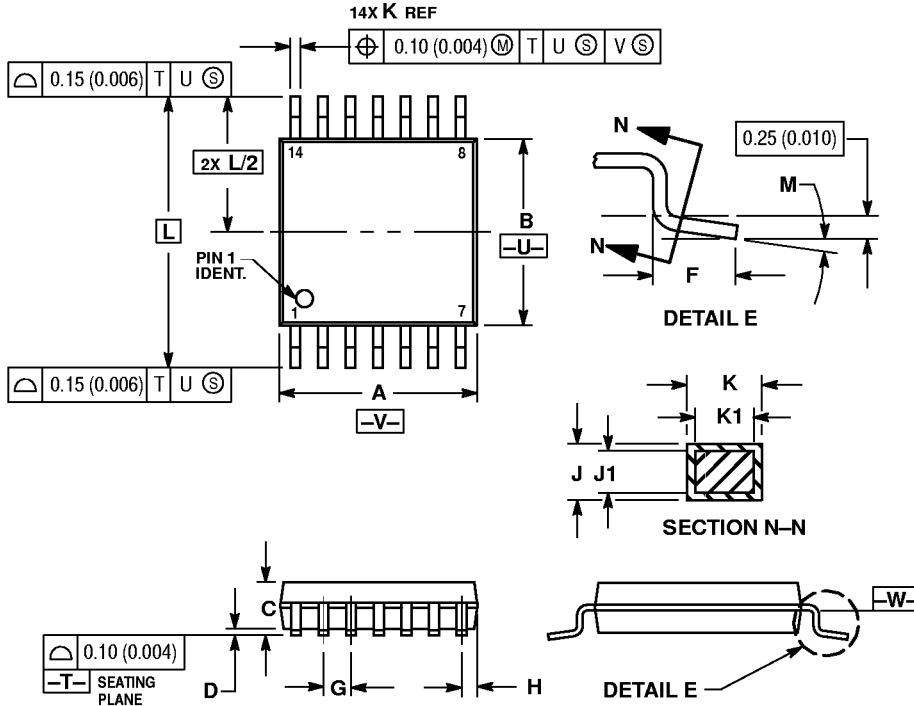
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 8.55        | 8.75 | 0.337     | 0.344 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.054     | 0.068 |
| D   | 0.35        | 0.49 | 0.014     | 0.019 |
| F   | 0.40        | 1.25 | 0.016     | 0.049 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| J   | 0.19        | 0.25 | 0.008     | 0.009 |
| K   | 0.10        | 0.25 | 0.004     | 0.009 |
| M   | 0°          | 7°   | 0°        | 7°    |
| P   | 5.80        | 6.20 | 0.228     | 0.244 |
| R   | 0.25        | 0.50 | 0.010     | 0.019 |

OUTLINE DIMENSIONS

DT SUFFIX  
 PLASTIC TSSOP PACKAGE  
 CASE 948G-01  
 ISSUE O



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.90        | 5.10 | 0.193     | 0.200 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | —           | 1.20 | —         | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.50        | 0.60 | 0.020     | 0.024 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

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